ALW-49P
Large Diameter Aluminum Wedge Bonding Wire

Excellent Thermal and Electrical Conductivity

ALW-49P wire has excellent thermal and electrical conductivity and can be used on all heavy wire wedge bonding equipment.

While normally supplied in an annealed state, Heraeus can also supply ALW-49P aluminum wedge bonding wire to meet mechanical specifications best suited to your equipment and the looping requirements of your application. Various spool colors are available that enable customization of wire diameter and spool color. Larger traverse dimension on spool allows for 2X wire length resulting in higher UPH.

ALW-49P Benefits
- Larger diameters suitable for power packages and discrete devices
- 3 mil – 20 mil thickness range prevents sag or deflection during molding
- Chemical and metallurgical behavior compatible with aluminum metallization
- Bondable at temperature and energy levels low enough to avoid damage to sensitive devices
- Enhanced corrosion resistance designed for non-hermetically sealed packages

Recommended Technical Data of ALW-49P

<table>
<thead>
<tr>
<th>Diameter (Microns)</th>
<th>125</th>
<th>150</th>
<th>200</th>
<th>250</th>
<th>300</th>
<th>380</th>
<th>500</th>
</tr>
</thead>
<tbody>
<tr>
<td>Breaking Load (g)</td>
<td>100 – 150</td>
<td>130 – 190</td>
<td>200 – 350</td>
<td>300 – 450</td>
<td>500 – 750</td>
<td>700 – 1000</td>
<td>1200 – 2000</td>
</tr>
<tr>
<td>Fusing Current (Amp)</td>
<td>5.4</td>
<td>6.9</td>
<td>10.6</td>
<td>15.2</td>
<td>19.9</td>
<td>27.9</td>
<td>42.7</td>
</tr>
</tbody>
</table>

For other diameters, please contact Heraeus Bonding Wires sales representative.
**Wire Specifications**

**Chemical Composition**
- Aluminum: 99.99%
- Total Impurities: 0.01%

**Physical Properties**
- Density: 2.70 g/cm³
- Melting Point: 660°C / 1220°F
- Electrical Resistivity @20°C: 2.7 µW/cm
- Thermal Conductivity @20°C: 230 W/m.K
- Electrical Conductivity @20°C: 64% IACS

**Aluminum Wire Map**

- **AlW29C, AlSi 1%**
- **AlW49C, Al-H11 CR**
- **AlW49P, Al-H11, Al-R**

**High Reliability of Aluminum Wedge Bonding**

The superior compatibility of aluminum wire with aluminum metallization allows for high integrity bonding at room temperatures using low ultrasonic energy to reduce the risk of damage to sensitive devices.

**Typical Wire Bonding Results**

- **Bond Shear Strength:**
  Minimum – tensile strength of the wire.

- **Wire Pull Strength:**
  Minimum – 50% of the tensile strength of the wire.